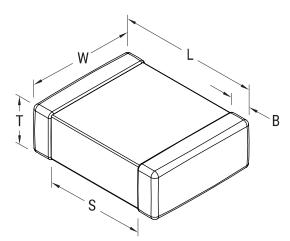


## C1206X162MATACAUTO7210

SMD Auto X8G HT150C Flex, Ceramic, 1,600 pF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Auto X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade
Features	High Temperature, Ultra-Stable, Automotive Grade
RoHS	Yes
Termination	Flexible Termination
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Chip Size 1206   L 3.3mm +/-0.4mm	
L 3.3mm +/-0.4mm	
W 1.6mm +/-0.35mm	
T 1mm +/-0.20mm	
S 1.5mm MIN	
B 0.6mm +/-0.25mm	

## **Packaging Specifications**

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	10000

Specifications	
Capacitance	1,600 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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